

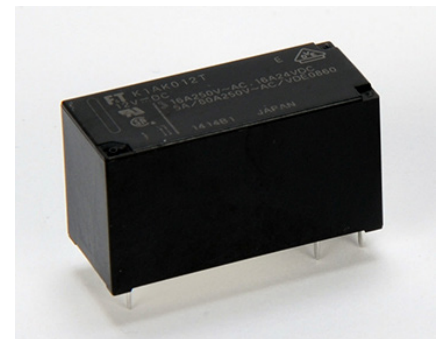
# POWER RELAY

## 1 POLE - 12A

### FTR-K1 Series

#### ■ FEATURES

- 12A
- 3.5mm and 5.0mm terminal pitch
- Low profile (height: 15.7mm)
- High insulation  
Insulation distance (between coil and contacts): 10mm min.  
Dielectric strength: 5KV  
Surge strength: 10KV
- Low coil power (400mW)
- Cadmium free contacts
- Safety standards  
UL, CSA, VDE approved
- UL F class wire insulation
- Flux proof, RT II
- RoHS compliant  
Please see page 7 for more information



#### ■ PARTNUMBER INFORMATION

[Example]      $\frac{\text{FTR-K1}}{\text{(a)}} \quad \frac{\text{C}}{\text{(b)}} \quad \frac{\text{K}}{\text{(c)}} \quad \frac{\text{012}}{\text{(d)}} \quad \frac{\text{W}}{\text{(e)}} - \frac{\text{MA}}{\text{(f)}} - \frac{\text{BG}}{\text{(g)}}$

(a)	Relay type	FTR-K1	: FTR-K1-Series
(b)	Contact configuration	A C	: 1 form A (SPST-NO) : 1 form C (SPDT)
(c)	Coil type / enclosure	K	: Standard (400mW) / flux proof
(d)	Coil rated voltage	012	: 5.....110 VDC Coil rating table at page 3
(e)	Contact material	W	: AgSnO <sub>2</sub>
(f)	Terminal pitch	MA MB	: 3.5mm pitch : 5.0mm pitch
(g)	Special type	Nil BG	: Standard type (without gold plate) : Gold plated 3 μm

Actual marking does not carry the type name : "FTR"

E.g.: Ordering code: FTR-K1CK012W-MA

Actual marking: K1CK012W-MA

# FTR-K1 SERIES

## ■ SPECIFICATION

Item			FTR-K1 (A,C) K ( ) W-MA	FTR-K1 (A,C) K ( ) W-MB	
Contact Data	Configuration		1 form A, 1 form C		
	Construction		Single		
	Material		W: AgSnO <sub>2</sub>		
	Resistance (initial)		Max. 100mΩ at 1A, 6VDC		
	Contact rating (resistive)		12A, 250VAC / 24VDC		
	Max. carrying current * <sup>1</sup>		14A		
	Max. switching voltage		440VAC / 300VDC		
	Max. switching power		3,000VA / 288W		
	Min. switching load * <sup>2</sup>		100mA, 5VDC		
Life	Mechanical		Min. 20 x 10 <sup>6</sup> operations		
	Electrical	AC contact rating	Min. 100 x 10 <sup>3</sup> operations		
		DC contact rating	Min. 100 x 10 <sup>3</sup> operations		
Coil Data	Rated power (20 °C)		400mW to 430mW		
	Operate power (20 °C)		196mW to 211mW		
	Operating temperature range		-40 °C to +85 °C (no frost)		
Timing Data	Operate (at nominal voltage)		Max. 15ms (without bounce)		
	Release (at nominal voltage)		Max. 5ms (without bounce, no diode)		
Insulation	Resistance (initial)		Min. 1,000MΩ at 500VDC		
	Dielectric strength	Open contacts	1,000VAC (50/60Hz) 1min		
		Contacts to coil	5,000VAC (50/60Hz) 1min		
	Surge strength	Coil to contacts	10,000V / 1.2 x 50μs standard wave		
	Clearance		10mm		
	Creepage		10mm		
	EN61810-1, VDE0435	Voltage		250V	
		Pollution degree		3	
Material group		III a			
Category		C / 250V (Reference voltage) (VDE0110b)			
Other	Vibration resistance	Misoperation≥1us	10 to 55 to 10Hz single amplitude 0.35mm		
		Endurance	10 to 55 to 10Hz single amplitude 0.75mm		
	Shock	Misoperation≥1us	100m/s <sup>2</sup> (11 ± 1ms)		
		Endurance	1,000m/s <sup>2</sup> (6 ± 1ms)		
	Weight		Approximately 13g		
	Sealing		Flux proof, RTII		

\* 1: Need to consider the heat from PCB when max. current is more than 10A.

\* 2: Minimum switching loads mentioned above are reference values. Please perform the confirmation test with actual load before production since reference values may vary according to switching frequencies, environmental conditions and expected reliability levels.

## ■ COIL RATING

Coil Code	Rated Coil Voltage (VDC)	Coil Resistance +/- 10% (Ohm)	Must Operate Voltage (VDC) *	Must Release-Voltage (VDC) *	Rated Power (mW)
005	5	62	3.5	0.5	400
006	6	90	4.2	0.6	
009	9	202	6.3	0.9	
012	12	360	8.4	1.2	
018	18	810	12.6	1.8	
022	22	1,210	15.4	2.2	
024	24	1,440	16.8	2.4	
028	28	1,960	19.6	2.8	
048	48	5,360	33.6	4.8	430
060	60	8,570	42.0	6.0	420
110	110	28,800	77.0	11.0	

Note: All values in the table are valid for 20°C and zero contact current.

\* Specified operate values are valid for pulse wave voltage.

Please use at rated coil voltage. Please refer to characteristic data and set up adequate voltage in case of use at over voltage.

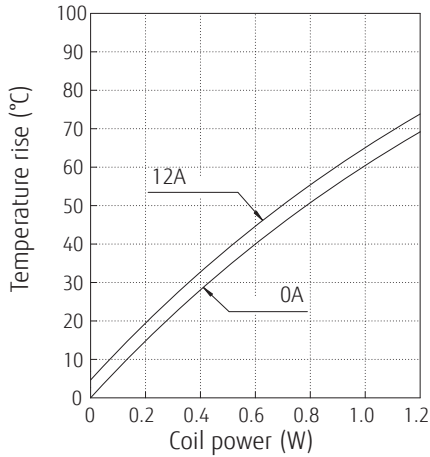
## ■ SAFETY STANDARDS

Type	Compliance	Contact rating	
		1 Form A	1 Form C
UL	UL 508	Flammability: UL 94-V0 (plastics)	
	E63614	FTR-K1AK( )W-(MA, MB) 12A/16A, 24 VDC (resistive), 85°C 12/16A, 277 VAC (resistive), 85°C 1/2hp, 277VAC, 85°C 1/3hp, 125VAC, 85°C Pilot duty: B300, 85°C	FTR-K1CK( )W-(MA, MB) 12A/16A, 24 VDC (resistive), 85°C 12A/16A, 277 VAC (resistive), 85°C 1/2hp, 277VAC, 85°C 1/3hp, 125VAC, 85°C 1/8hp, 125VAC, 85°C Pilot duty: B300, 85°C
CSA	C22.2 No. 14 LR 40304	FTR-K1(A,C)K( )W-(MA, MB) 12A, 277VAC/24VDC (resistive) 16A, 277 VAC/24VDC (resistive) 1/2 hp, 277VAC 1/3 hp, 125VAC Pilot duty: B300	
VDE	IEC/EN61810-1 EN60335-1 clause 15.3; 16.3; 29.1; 29.2; 29.3 EN60730 clause 12.2; 13.2; 20.1; 20.2; 20.3	FTR-K1(A, C) K ( )W-(MA, MB) 12A, 250 VAC (cosφ=1), 85 °C 16A, 250 VAC (cosφ=1), 85 °C 12A, 24VDC (0ms), 85 °C 16A, 24VDC (0ms), 85 °C 3.5A, 250 VAC (cosφ=0.4), 85 °C	

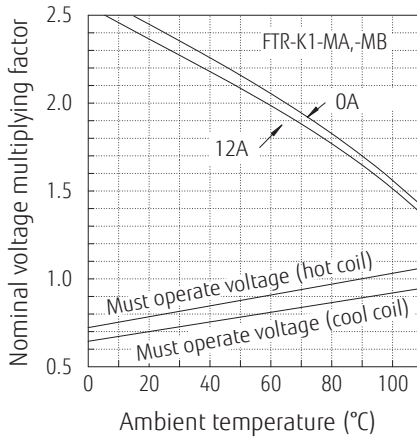
## CHARACTERISTIC DATA (Reference)

\* Characteristic data is not a guaranteed value, but measured values of samples from production line.

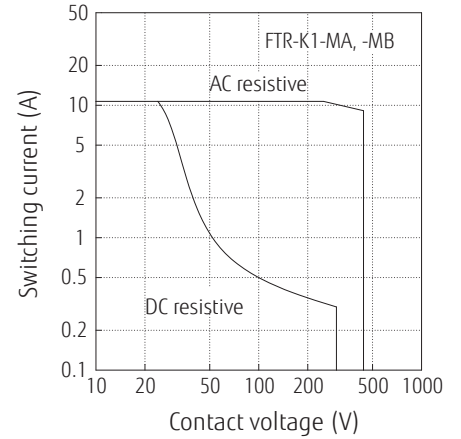
Coil temperature rise



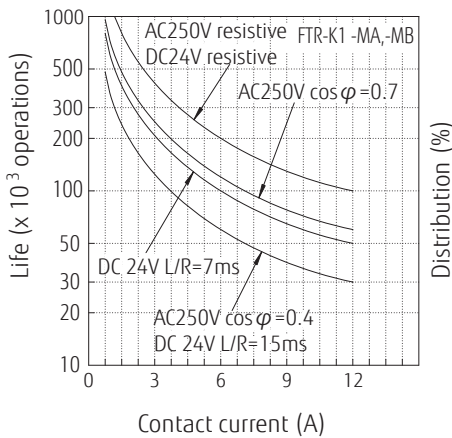
Operating range



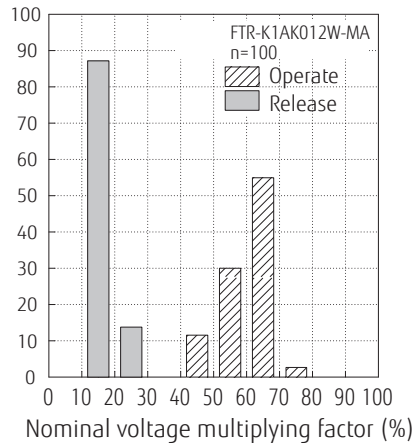
Maximum switching power



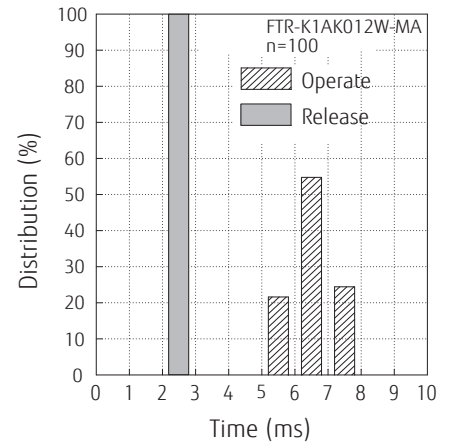
Life curve



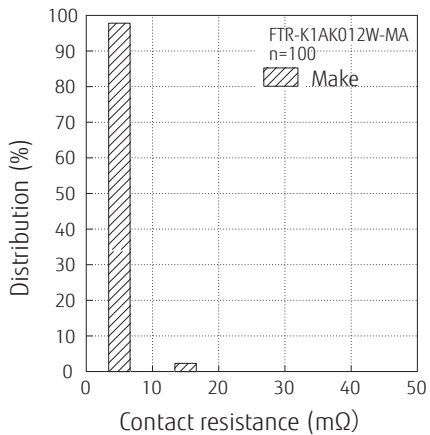
Distribution of operate, release voltage



Distribution of operate, release time



Distribution of contact resistance

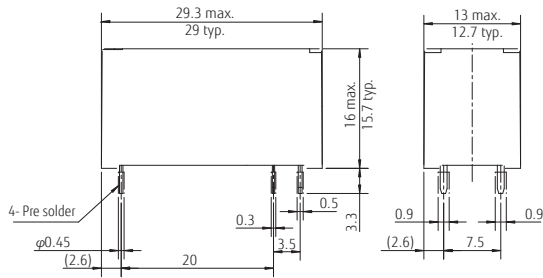


# FTR-K1 SERIES

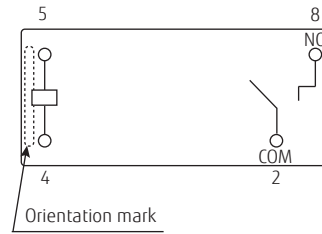
## ■ DIMENSIONS

FTR-K1AK( )W-MA

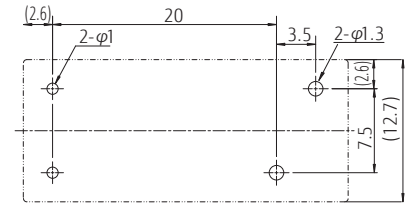
### ● Dimensions



### ● Schematics

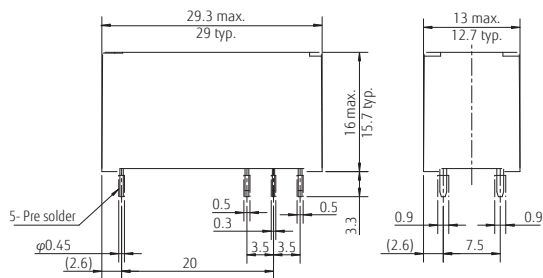


### ● PC board mounting hole layout (BOTTOM VIEW)

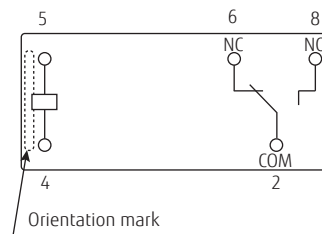


FTR-K1CK( )W-MA

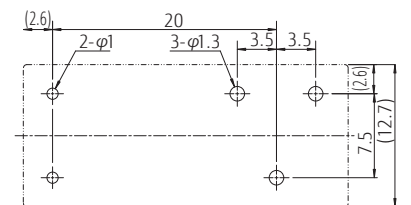
### ● Dimensions



### ● Schematics



### ● PC board mounting hole layout (BOTTOM VIEW)



\* Dimensions of the terminals do not include thickness of pre-solder.

\* Tolerance of PC board mounting hole layout :  $\pm 0.1$  unless otherwise specified.

\* Dimensions do not include tolerances. Please ask specification in case you need tolerances.

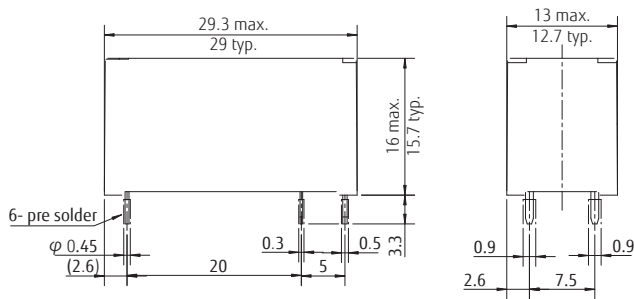
Unit: mm

# FTR-K1 SERIES

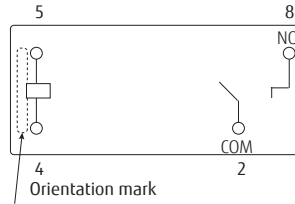
## ■ DIMENSIONS

FTR-K1AK( )W-MB

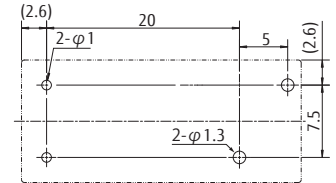
### ● Dimensions



### ● Schematics

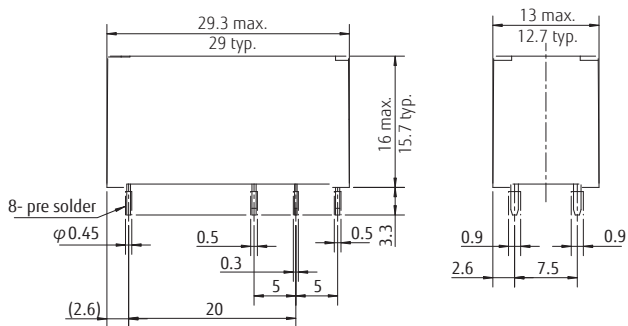


### ● PC board mounting hole layout (BOTTOM VIEW)

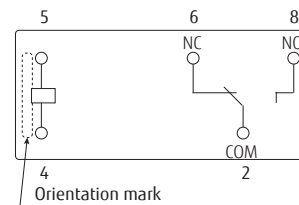


FTR-K1CK( )W-MB

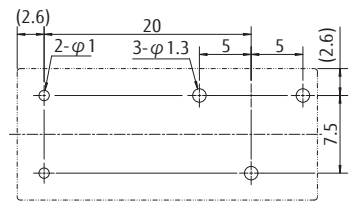
### ● Dimensions



### ● Schematics



### ● PC board mounting hole layout (BOTTOM VIEW)



\* Dimensions of the terminals do not include thickness of pre-solder.

\* Tolerance of PC board mounting hole layout :  $\pm 0.1$  unless otherwise specified.

Unit: mm

## Cautions

- All values mentioned in this datasheet are provided under ideal conditions. Please perform the confirmation test before actual use.
- Reflow soldering is prohibited.
- Do not use relays in the atmosphere with sulfide gas, chloride gas or nitric oxide. Contact resistance may increase.
- Do not use silicon or silicon-containing product or materials near relays. It may cause contact failure.

## RoHS Compliance and Lead Free Information

### 1. General Information

- All relays produced by Fujitsu Components are compliant with RoHS directive 2011/65/EU including amendments.
- Cadmium as used in electrical contacts is exempted from the RoHS directives. As per Annex III of directive 2011/65/EU.
- All relays are lead-free. Please refer to Lead-Free Status Info for older date codes at: <http://www.fujitsu.com/downloads/MICRO/fcai/relays/lead-free-letter.pdf>
- Lead free solder plating on relay terminals is Sn-3.0Ag-0.5Cu, unless otherwise specified. This material has been verified to be compatible with PbSn assembly process.

### 2. Recommended Lead Free Solder Condition

- Recommended solder Sn-3.0Ag-0.5Cu.

#### Flow Solder Condition:

Pre-heating: maximum 120°C  
within 90 sec.  
Soldering: dip within 5 sec. at  
255°C ± 5°C solder bath  
Relay must be cooled by air immediately  
after soldering

#### Solder by Soldering Iron:

Soldering Iron 30-60W  
Temperature: maximum 350-360°C  
Duration: maximum 3 sec.

**We highly recommend that you confirm your actual solder conditions**

### 3. Moisture Sensitivity

- Moisture Sensitivity Level standard is not applicable to electromechanical relays, unless otherwise indicated.

### 4. Tin Whiskers

- Dipped SnAgCu solder is known as presenting a low risk to tin whisker development. No considerable length whisker was found by our in house test.

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